

August 2026 Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.

Mark your calendars. **The September Report SEAJ's Web site update** is scheduled on **21st October** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts **August 2026 Billings of ¥597,915 million**

Tokyo Japan, **September 18th, 2026** JAPAN-based manufacturers of semiconductor equipment posted **¥597,915 million** in billings in **August 2026**(three-month average basis) published today by SEAJ.

The billings figure is **7.5 percent up** the final **July 2026** level of **¥556,220 million** and **47.4 percent up** the **2025 August** billings level of **¥405,764 million**.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
March 2026	480,182	13.5%	11.1%
April 2026	510,155	6.2%	14.1%
May 2026	526,352	3.2%	17.9%
June 2026	513,610	-2.4%	26.9%
July 2026(final)	556,220	8.3%	35.4%
August 2026(prelim)	597,915	7.5%	47.4%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

CONTACT : Akihide Kobayashi Secretary General & General Manager of Public Relations Department
SEAJ

Web <https://www.seaj.or.jp> E-mail akobayashi@seaj.or.jp